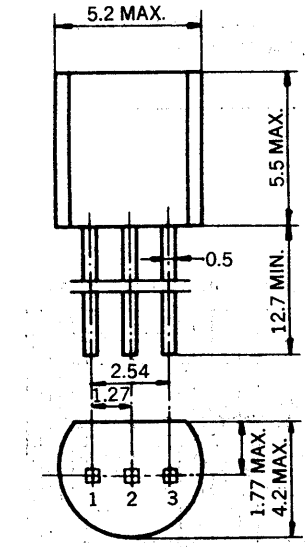
DATA SHEET

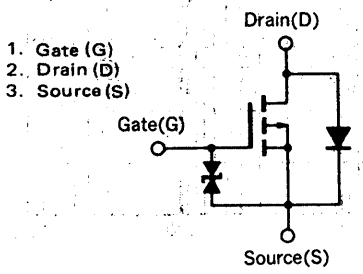
NEC

MOS FIELD EFFECT TRANSISTOR
2SJ198

P-CHANNEL MOS FET
FOR SWITCHING

OUTLINE DIMENSIONS (Unit : mm)





(Diode in the above figure is a parasitic diode.)

The 2SJ198 is a p-channel vertical type MOS FET switching device which can be directly driven from an IC operating with a 5 V single power supply. The device featuring low ON-state resistance is of the voltage drive type and thus is ideal for driving actuators such as motors, solenoids, and relays.

FEATURES

- Low ON-state resistance
  $R_{DS(on)}$ = 2.5 Ω MAX. at V_{GS} = −4 V, I_D = −0.5 A
  $R_{DS(on)}$ = 2.0 Ω MAX. at V_{GS} = −10 V, I_D = −0.5 A
- Voltage drive at logic level (V_{GS} = −4 V) is possible.
- Bidirectional zener diode for protection is incorporated in between the Gate and the Source.
- Inductive loads can be driven without protective circuit thanks to the improved breakdown voltage between the Drain and Source.
- Complementary to 2SK1484

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C)

CHARACTERISTIC	SYMBOL	RATINGS	UNIT	TEST CONDITIONS
Drain to Source Voltage	V_{DSS}	−100	V	V_{GS} = 0
Gate to Source Voltage	V_{GSS}	∓20	V	V_{DS} = 0
Drain Current (DC)	$I_{D(DC)}$	∓0.5	A	
Drain Current (pulse)	$I_{D(pulse)}$	∓1.0	A	PW ≦ 10 ms, Duty Cycle ≦ 50 %
Total Power Dissipation	P_T	750	mW	
Channel Temperature	T_{ch}	150	°C	
Storage Temperature	T_{stg}	−55 to +150	°C	

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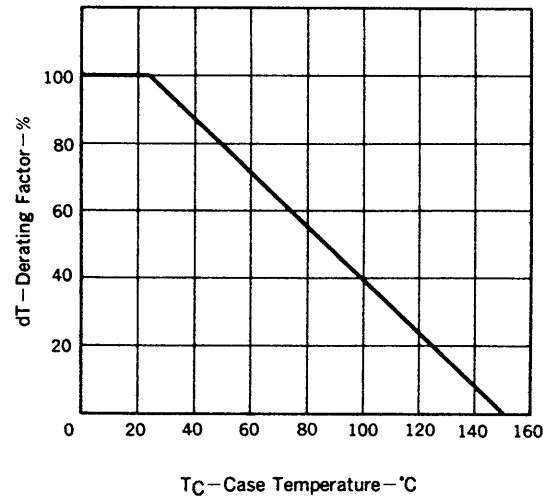
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

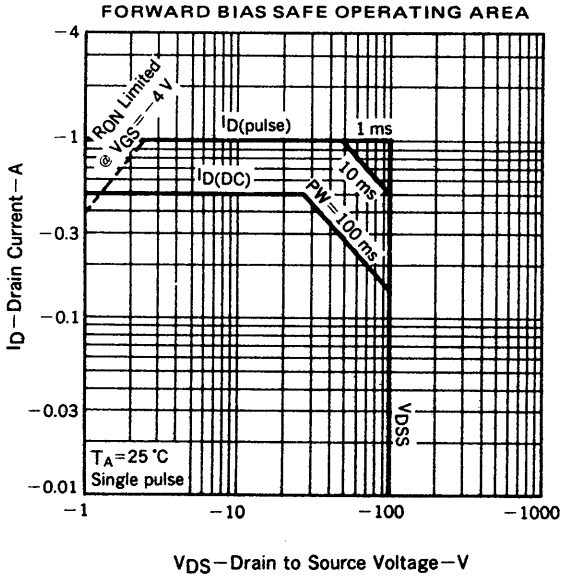
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Drain Cut-off Current	I_{DSS}			−10	μA	V_{DS} = −100 V, V_{GS} = 0
Gate Leakage Current	I_{GSS}			∓10	μA	V_{GS} = ∓20 V, V_{DS} = 0
Gate Cut-off Voltage	$V_{GS(off)}$	−1.0	−2.1	−3.0	V	V_{DS} = −10 V, I_D = −1 mA
Forward Transfer Admittance	$\|y_{fs}\|$	0.4	0.9		S	V_{DS} = −10 V, I_D = −0.5 A
Drain to Source On-State Resistance	$R_{DS(on)1}$		1.5	2.5	Ω	V_{GS} = −4.0 V, I_D = −0.5 A
Drain to Source On-State Resistance	$R_{DS(on)2}$		1.1	2.0	Ω	V_{GS} = −10 V, I_D = −0.5 A
Input Capacitance	C_{iss}		220		pF	V_{DS} = −10 V, V_{GS} = 0, f = 1 MHz
Output Capacitance	C_{oss}		85		pF	
Feedback Capacitance	C_{rss}		8		pF	
Turn-On Delay Time	$t_{d(on)}$		45		ns	$V_{GS(on)}$ = −10 V, R_G = 10 Ω, V_{DD} = −25 V, I_D = −0.5 A, R_L = 50 Ω
Rise Time	t_r		36		ns	
Turn-Off Delay Time	$t_{d(off)}$		360		ns	
Fall Time	t_f		90		ns	

TYPICAL CHARACTERISTICS (T_A = 25 °C)

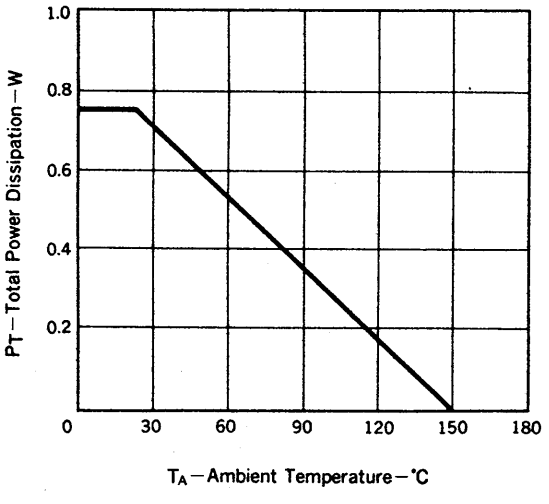
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



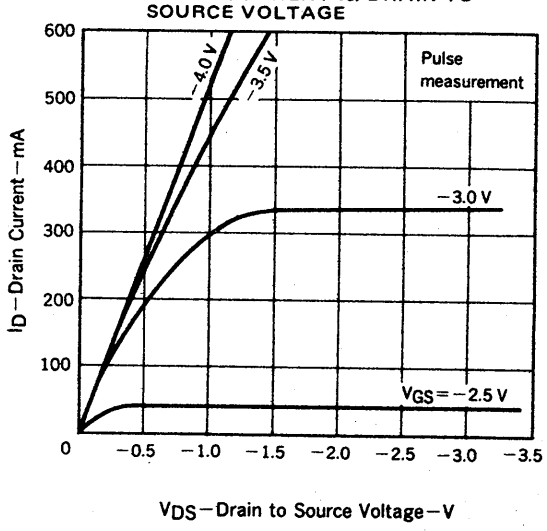
FORWARD BIAS SAFE OPERATING AREA



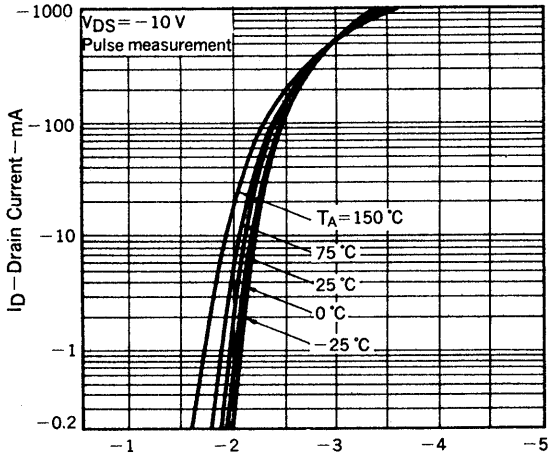
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



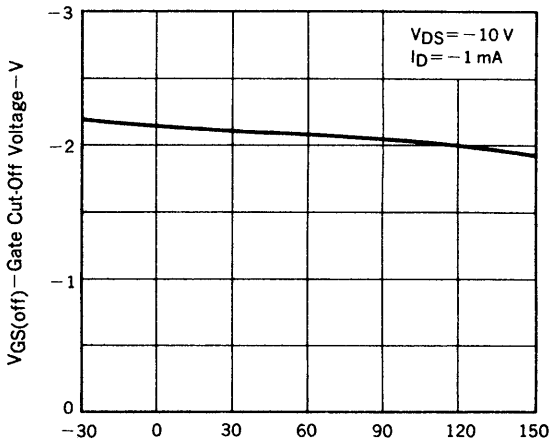
TRANSFER CHARACTERISTICS



ID − Drain Current − mA

VGS − Gate to Source Voltage − V

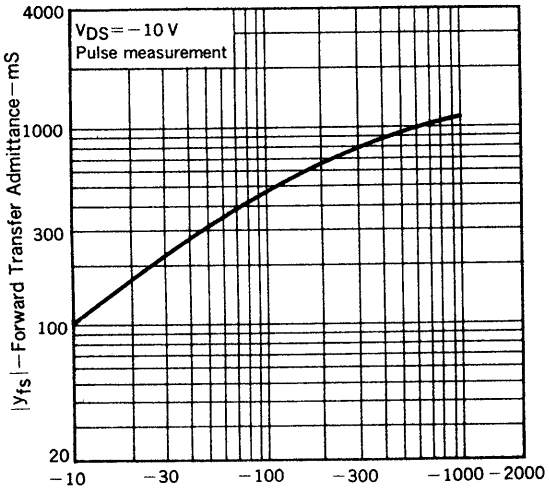
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



VGS(off) − Gate Cut-Off Voltage − V

Tch − Channel Temperature − °C

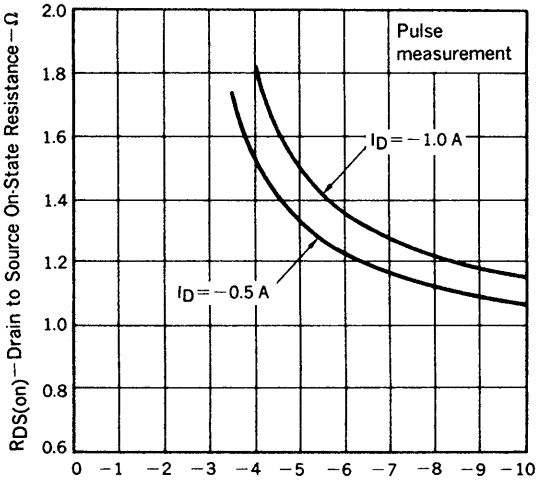
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



|yfs| − Forward Transfer Admittance − mS

ID − Drain Current − mA

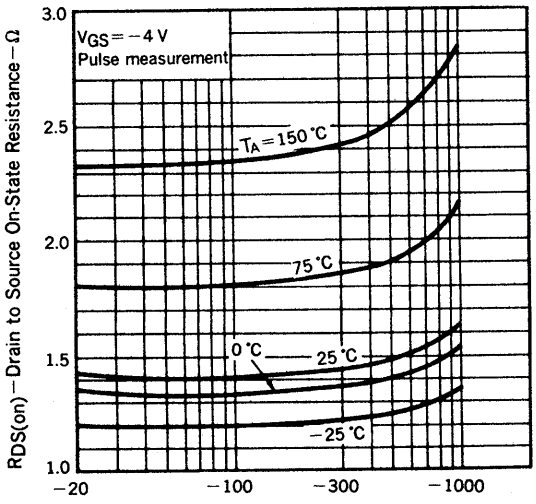
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



RDS(on) − Drain to Source On-State Resistance − Ω

VGS − Gate to Source Voltage − V

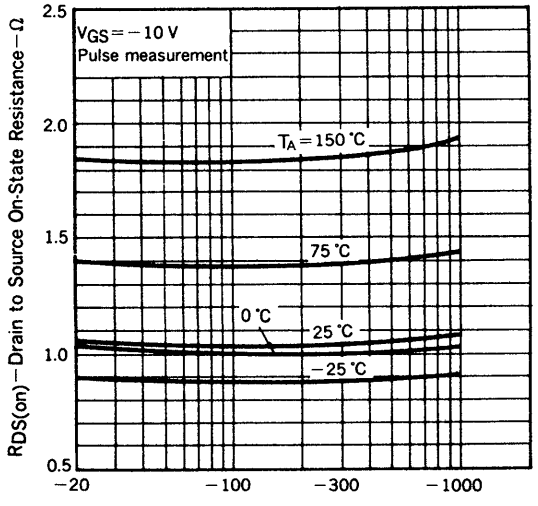
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



RDS(on) − Drain to Source On-State Resistance − Ω

ID − Drain Current − mA

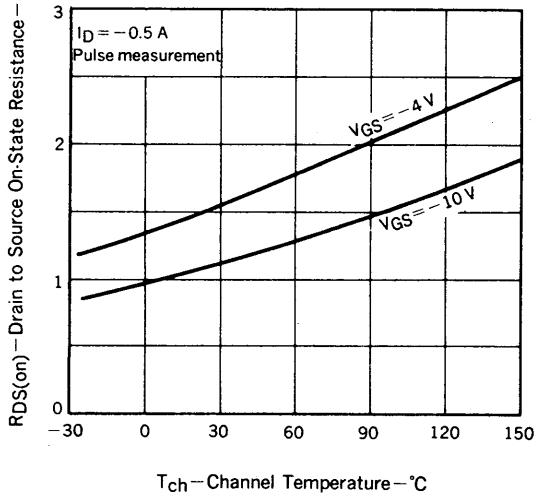
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



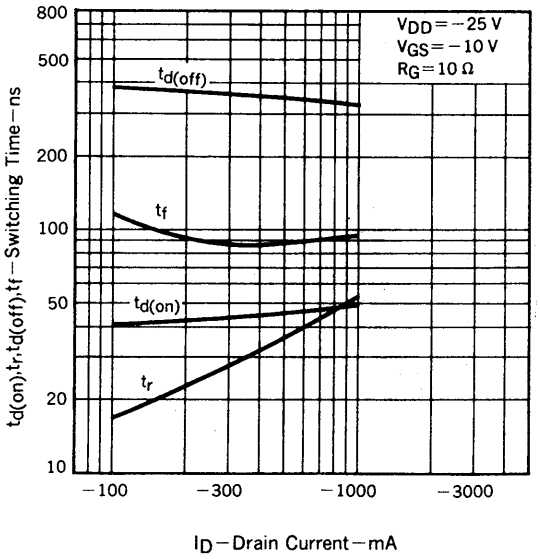
RDS(on) − Drain to Source On-State Resistance − Ω

ID − Drain Current − mA

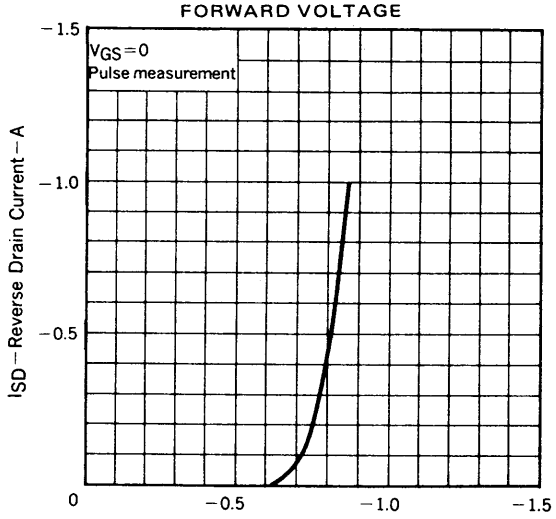
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



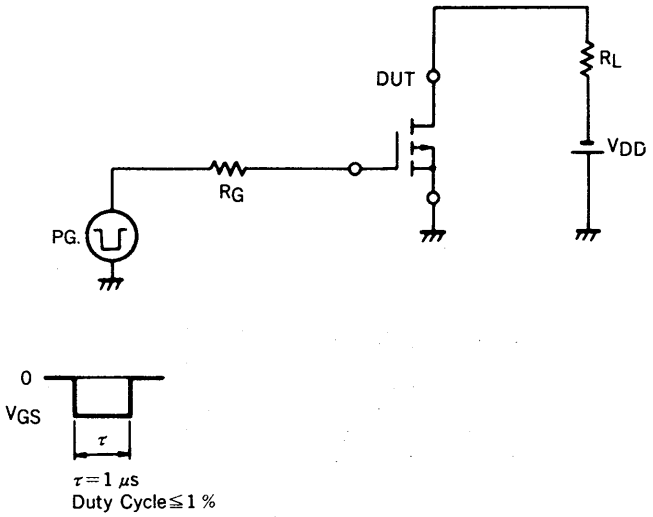
SWITCHING CHARACTERISTICS



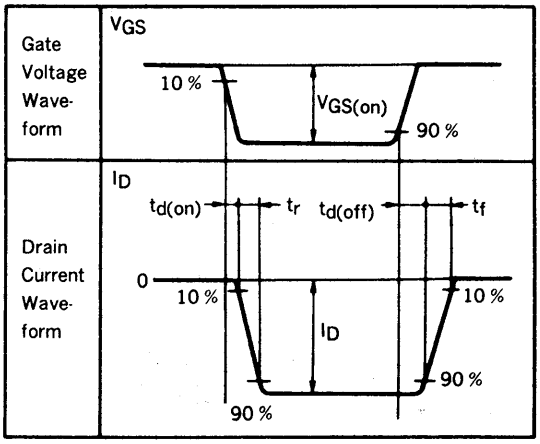
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS



τ = 1 μs
Duty Cycle ≦ 1 %



RECOMMENDED SOLDERING CONDITIONS

Solder this product under the following recommended conditions.
For soldering methods or soldering conditions other than those recommended in the table, please consult our NEC salespeople.

Insert type

Soldering method	Soldering conditions	Recommended condition code
Wave soldering	Solder bath temperature: 260 °C max. Soldering time: 10 sec max.	

[MEMO]

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